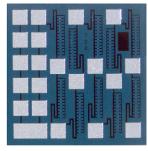


**Vishay Electro-Films** 

# Wire Bondable Thin Film Multi-Tap Resistor Arrays



Product may not be to scale

The MTT multi-tap resistors offer nineteen taps allowing the user to select specified increments and a wide range of values. The desired resistance value is obtained by bonding the wires to the appropriate pads.

These chips are manufactured using Vishay Electro-Films (EFI) sophisticated Thin Film equipment and manufacturing technology. The MTT's are 100 % electrically tested and visually inspected to MIL-STD-883, method 2032 class H or K.

## FEATURES

- Wire bondable
- Selectable values by wire bonding
- Resistance range: 1.1 k $\Omega$  to 275 k $\Omega$
- Chip size: 0.038" x 0.038"
- Case: 0404
- Resistor material tantalum nitride, self-passivating
- Oxidized silicon substrate for good power dissipation
- · Ideally suited for hybrid prototyping
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## APPLICATIONS

The MTT series of multi-tap resistor chips are designed to satisfy the requirements of prototype development and circuit trimming in hybrid packages through selective wire-bonding.

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES						
PARAMETER	VALUE	UNIT   Ω				
Total Resistance Range	1.1K, 2.75K, 5.5K, 11K, 27.5K, 55K, 110K, 275K					
10 Resistors Between Pads 1 and 11 10 Resistors Between Pads 11 and 21	Each 9.1 % of total resistance Each 0.91 % of total resistance					
Standard Tolerances	$\pm$ 1, $\pm$ 5, $\pm$ 10, $\pm$ 20 of total resistance of all 20 resistors	%				
TCR	± 250	ppm/°C				

#### Example:

When the total resistance value is 55 k $\Omega$ , the resistors between pads 11 and 21 are 500  $\Omega$  each, and the resistors between pads 1 and 11 are 5 k $\Omega$  each.

STANDARD ELECTRICAL SPECIFICATIONS					
PARAMETER	VALUE	UNIT			
TCR Tracking Between Elements	± 5	ppm/°C			
Noise, MIL-STD-202, Method 308	-30 typ.	dB			
Moisture Resistance, MIL-STD-202, Method 106	± 0.5 max. ∆R/R	%			
Stability, 1000 h, +125 °C, 125 mW	± 0.5 max. Δ <i>R/R</i>	%			
Operating Temperature Range	-55 to +125	°C			
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	± 0.25 max. Δ <i>R/R</i>	%			
High Temperature Exposure +150 °C, 100 h	± 0.5 max. Δ <i>R/R</i>	%			
Dielectric Voltage Breakdown	200	V			
Insulation Resistance	10 <sup>12</sup> min.	Ω			
Operating Voltage	100 max.	V			
DC Power Rating at +70 °C (Derated to Zero at +175 °C)	0.250, total <i>R</i>	W			
5 x Rated Power Short-Time Overload, +25 °C, 5 s	± 0.25 max. Δ <i>R/R</i>	%			

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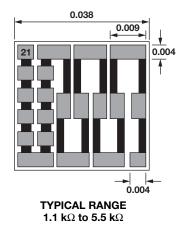
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Pb-free

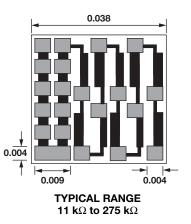
RoHS COMPLIANT HALOGEN FREE GREEN (5-2008)

## **DIMENSIONS** in inches

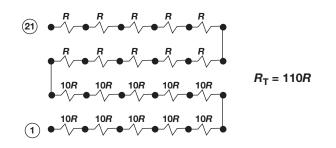
ISHA



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## SCHEMATIC



MECHANICAL SPECIFICATIONS					
PARAMETER					
Chip Size	0.038" x 0.038" ± 0.002" (0.965 mm x 0.965 mm ± 0.05 mm)				
Chip Thickness	0.010" ± 0.002" (0.254 mm ± 0.05 mm)				
Chip Substrate Material	Oxidized silicon, 10 kÅ minimum SiO2				
Resistor Material	Tantalum nitride, self-passivating				
nding Pads 0.004" x 0.004" (0.10 mm x 0.10 mm)					
Number of Pads	21				
Pad Material	10 kÅ minimum aluminum				
Backing	None, lapped semiconductor silicon				

Global Par	t Number: MTT11	002KMANHWS						
Global Par	t Number Descrip	otion: MTT 110K	10 %, 250 p	opm/°C, Al ter	mination, no back	metal, class	H, WS	
Μ	<u> </u>	1 1 0	0	2 K	MA	NH	WS	]
MODEL	RESISTANCE	RESISTANCE MULTIPLIER CODE	TOL. CODE (%)	TCR (ppm/°C)	TERMINATION	BACK METAL	VISUAL CLASS	PACKAGING CODE
MTT	First 4 digits are significant figures of	A = 0.1 0 = 1 1 = 10	F = 1.0 G = 2.0 J = 5.0	$C = \pm 50$ $K = \pm 100$ $M = \pm 250$	$\mathbf{G} = \text{gold}$ $\mathbf{A} = \text{aluminum}$	<b>G</b> = gold <b>N</b> = none	H = class H K = class K	<b>WS</b> = waffle pack 100 min,
	resistance	<b>2</b> = 100	K = 10 M = 20 L = 25	R = 0 / -250				1 mult.

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